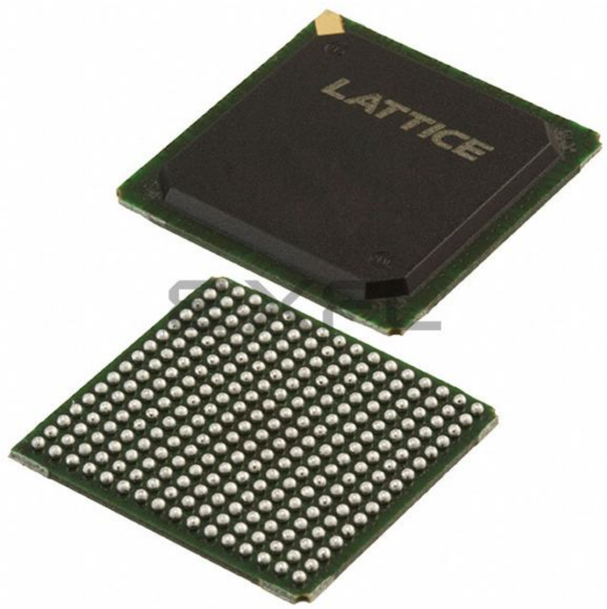


Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details	
Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	5 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	8
Number of Macrocells	256
Number of Gates	-
Number of I/O	141
Operating Temperature	-40°C ~ 105°C (TJ)
Mounting Type	Surface Mount
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc5256mv-5fn256i

Cascading For Wide Operation

In several modes it is possible to cascade adjacent MFBs to support wider operation. Table 2 details the different cascading options. There are chains of MFBs in each device which determine those MFBs that are adjacent for the purposes of cascading. Table 3 indicates these chains. The ispXPLD 5000MX design tools automatically cascade blocks if required by a particular design.

Table 2. Cascading Modes For Wide Support

Mode	Cascading Function
Logic	**Input Width.** Allows two MFBs to act as a 136-input block.
	Arithmetic. Allow the carry chain to pass between two MFBs.
FIFO	**Memory Width Expansion.** Allows MFBs to be cascaded for greater width support.
CAM	**Memory Width Expansion.** Allows up to four MFBs to be cascaded for greater width support.

Table 3. MFB Cascade Chain

Device	MFBs in Cascade Chain
ispXPLD 5256MX	A → B → C → D
	H -> G -> F -> E
ispXPLD 5512MX	A → B → C → D → E → F → G → H
	P → O → N → M → L → K → J → I
ispXPLD 5768MX	D → C → B → A → X → W → V → U → T → S → R → Q
	E → F → G → H → I → J → K → L → M → N → O → P
ispXPLD 51024MX	H → G → F → E → D → C → B → A → AF → AE → AD → AC → AB → AA → Z → Y
	I → J → K → L → M → N → O → P → Q → R → S → T → U → V → W → X

SuperWIDE Logic Mode

In logic mode, each MFB contains 32 macrocells and a fully populated, programmable AND-array with 160 logic product terms and four control product terms. The MFB has 68 inputs from the Global Routing Pool, which are available in both true and complement form for every product term. It is also possible to cascade adjacent MFBs to create a block with 136 inputs. The four control product terms are used for shared reset, clock, clock enable, and output enable functions. Figure 3 shows the overall structure of the MFB in logic mode while Figure 4 provides a more detailed view from the perspective of a macrocell slice.

Single-Port SRAM Mode

In Single-Port SRAM Mode the multi-function array is configured as a single-port SRAM. In this mode one ports accesses 16,384-bits of memory. Data widths of 1, 2, 4, 8, 16 and 32 are supported by the MFB. Figure 11 shows the block diagram of the single-port SRAM.

Write data, address, chip select and read/write signals are always synchronous (registered.) The output data signals can be synchronous or asynchronous. Reset is asynchronous. All signals share a common clock, clock enable, and reset. Table 7 shows the possible sources for the clock, clock enable and reset signals.

Figure 11. Single-Port SRAM Block Diagram

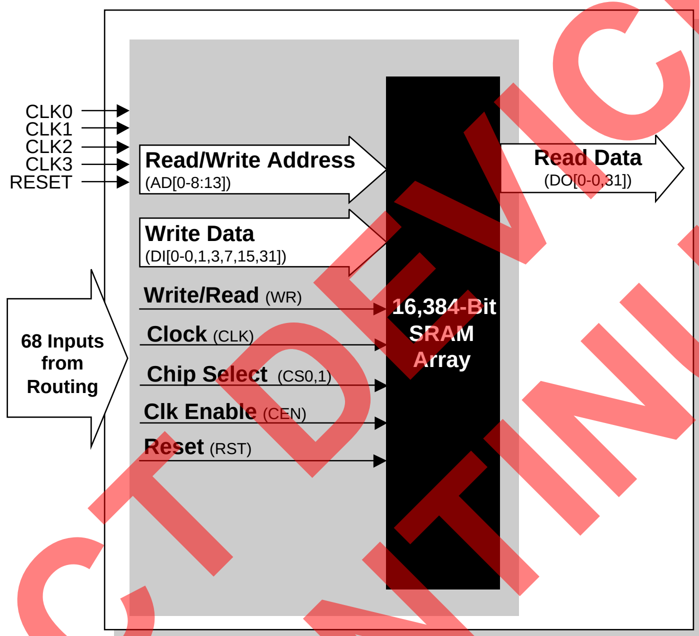


Table 7. Register Clock, Clock Enable, and Reset in Single-Port SRAM Mode

Register	Input	Source
Address, Write Data, Read Data, Read/ Write, and Chip Select	Clock	CLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	CEN or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RST. RST is routed by the multifunction array from GRP, with inversion if desired.

FIFO Mode

In FIFO Mode the multi-function array is configured as a FIFO (First In First Out) buffer with built in control. The read and write clocks can be different or the same dependent on the application. Four flags show the status of the FIFO; Full, Empty, Almost Full, and Almost Empty. The thresholds for Full, Almost full and Almost empty are programmable by the user. It is possible to reset the read pointer, allowing support of frame retransmit in communications applications. If desired, the block can be used in show ahead mode allowing the early reading of the next read address.

In this mode one ports accesses 16,384-bits of memory. Data widths of 1, 2, 4, 8, 16 and 32 are supported by the MFB. Figure 12 shows the block diagram of the FIFO.

Write data, write enable, flag outputs and read enable are synchronous. The Write Data, Almost Full and Full share the same clock and clock enables. Read outputs are synchronous although these can be configured in look ahead mode. The Read Data, Empty and Almost Empty signals share the same clock and clock enables. Reset is shared by all signals. Table 8 shows the possible sources for the clock, clock enable and reset signals for the various registers.

Figure 12. FIFO Block Diagram

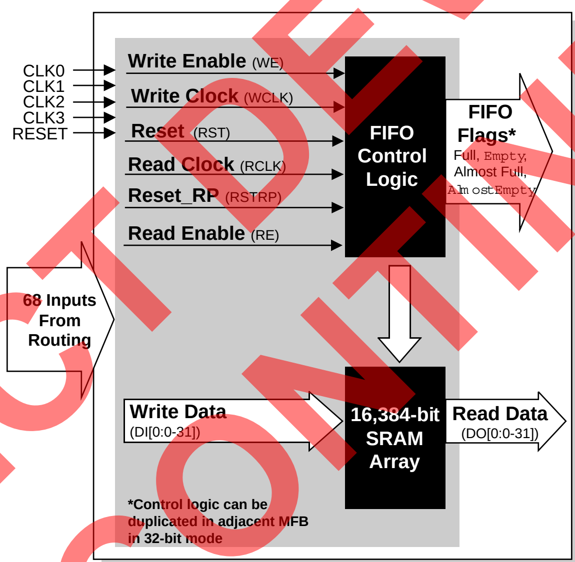


Table 8. Register Clocks, Clock Enables, and Initialization in FIFO Mode

Register	Input	Source
Write Data, Write Enable	Clock	WCLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	WE or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	N/A
Full and Almost Full Flags	Clock	WCLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	WE or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RST. RST is routed by the multifunction array from GRP, with inversion if desired.
Read Data, Empty and Almost Empty Flags	Clock	RCLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	RE or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RST. RST is routed by the multifunction array from GRP, with inversion if desired.

CAM Mode

In CAM Mode the multi-function array is configured as a Ternary Content Addressable Memory (CAM). CAM behaves like a reverse memory where the input is data and the output is an address. It can be used to perform a variety of high-performance look-up functions. As such, CAM has two modes of operation. In write or update mode the CAM behaves as a RAM and data is written to the supplied address. In read or compare operations data is supplied to the CAM and if this matches any of the data in the array the Match and Multiple Match (if there is more than one match) flags are set to true and the lowest address with matching data is output. The CAM contains 128 entries of 48 bits. Figure 13 shows the block diagram of the CAM.

To further enhance the flexibility of the CAM a mask register is available. If enabled during updates, bits corresponding with those set to 1 in the mask register are not updated. If enabled during compare operations, bits corresponding to those set to 1 in the mask register are not included in the compare. A write don't care signal allows don't cares to be programmed into the CAM if desired. Like other write operations the mask register controls this.

The write/comp data, write address, write enable, write chip select, and write don't care signals are synchronous. The CAM Output signals, match flag, and multimatch flag can be synchronous or asynchronous. The Enable mask register input is not latched but must meet setup and hold times relative to the write clock. All inputs must use the same clock and clock enable signals. All outputs must use the same clock and clock enable signals. Reset is common for both inputs and outputs. Table 9 shows the allowable sources for clock, clock enable, and reset for the various CAM registers.

Figure 13. CAM Mode

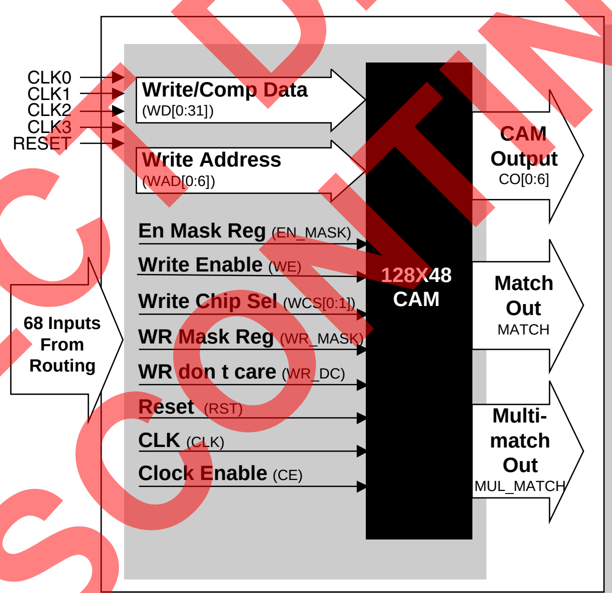


Table 9. Register Clocks, Clock Enables, and Initialization in CAM Mode

Register	Input	Source
Write data, Write address, Enable mask register, Write enable, write chip select, and write don't care, CAM Output, Match, and Multimatch	Clock	CLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	WE or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RST. RST is routed by the multifunction array from GRP, with inversion if desired

Figure 15. PLL Block Diagram

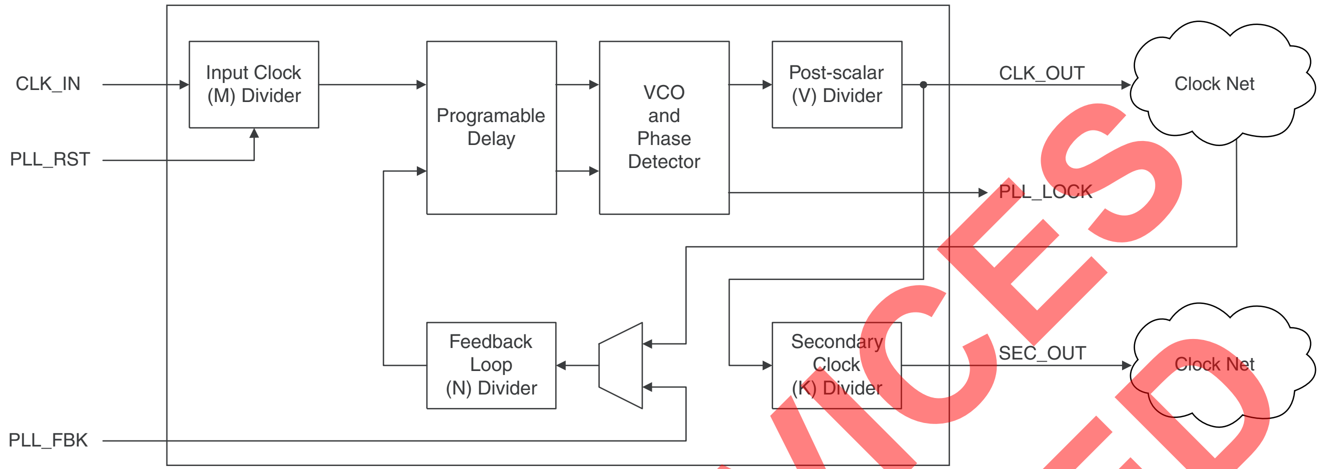
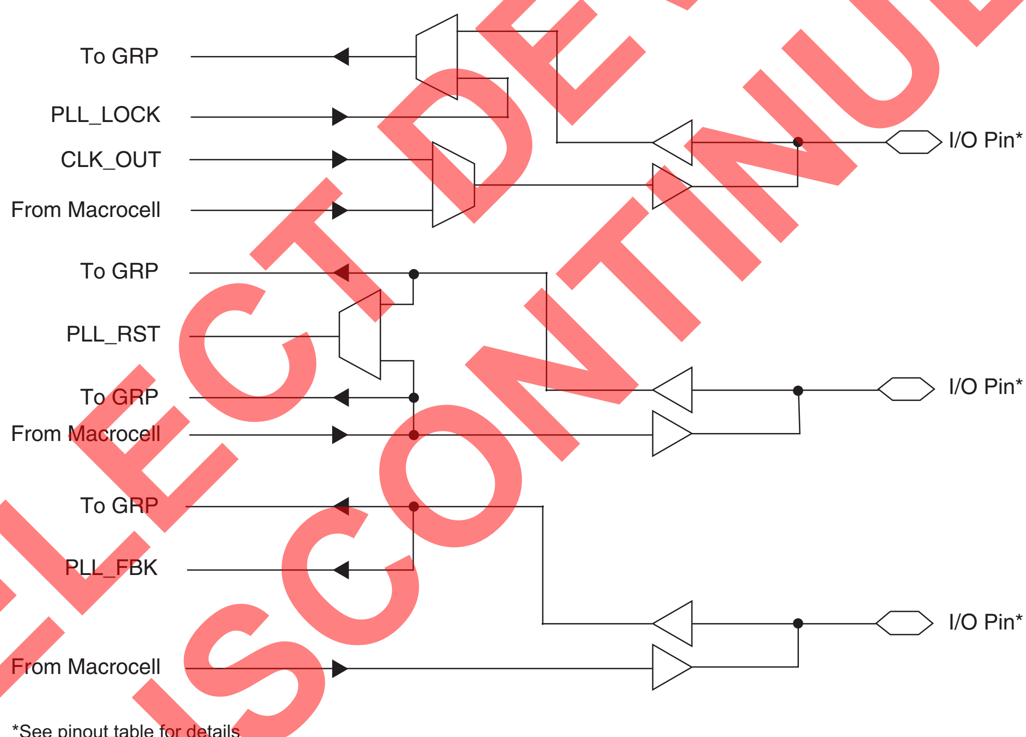


Figure 16. Connection of Optional PLL Inputs and Outputs



In order to facilitate the multiply and divide capabilities of the PLL, each PLL has dividers associated with it: M, N and K. The M divider is used to divide the clock signal, while the N divider is used to multiply the clock signal. The K divider is only used when a secondary clock output is needed. This divider divides the primary clock output and feeds to a separate global clock net. The V divider is used to provide lower frequency output clocks, while maintaining a stable, high frequency output from the PLL's VCO circuit. The PLL also has a delay feature that allows the output clock to be advanced or delayed to improve set-up and clock-to-out times for better performance. For more information on the PLL, please refer to TN1003, sysCLOCK PLL Usage Guide for ispXPGA, ispGDX2, ispXPLD and ispMACH 5000VG Devices.

Table 12. ispXPLD 5000MX Supported I/O Standards

sysIO Standard	Nominal V_{CCO}	Nominal V_{REF}	Nominal V_{TT}
LVTTL	3.3V	N/A	N/A
LVCMOS-3.3	3.3V	N/A	N/A
LVCMOS-2.5	2.5V	N/A	N/A
LVCMOS-1.8	1.8V	N/A	N/A
PCI 3.3V	3.3V	N/A	N/A
AGP-1X	3.3V	N/A	N/A
SSTL3, Class I & II	3.3V	1.5V	1.5V
SSTL2, Class I & II	2.5V	1.25V	1.25V
CTT 3.3	3.3V	1.5V	1.5V
CTT 2.5	2.5V	1.25V	1.25V
HSTL, Class I	1.5V	0.75V	0.75V
HSTL, Class III	1.5V	0.9V	0.75V
HSTL, Class IV	1.5V	0.9V	0.75V
GTL+	N/A	1.0V	1.5V
LVPECL, Differential	2.5V, 3.3V	N/A	N/A
LVDS	2.5V, 3.3V	N/A	N/A

Table 13. Differential Interface Standard Support[1]

		sysIO Buffer
LVDS	Driver	Supported
	Receiver	Supported with standard termination
LVPECL	Driver	Supported with external resistor network
	Receiver	Supported with termination

1. For more information, refer to TN1000 – sysIO Usage Guidelines for Lattice Devices.

Control, Clock, sysCONFIG and JTAG Signals

Global clock pins support the same sysIO standards as general purpose I/O. When required the V_{REF} signal is derived from the adjacent bank. When differential standards are supported two adjacent clock pins are paired to form the input. The TOE, PROGRAM, CFG0 and DONE pins of the ispXPLD 5000MX device are the only pins that do not have sysIO capabilities. The JTAG TAP pins support only LVCMOS 3.3, 2.5 and 1.8V standards. The voltage is controlled by V_{CCJ}. These pins only support the LVTTL and LVCMOS standards applicable to the power supply voltage of the device. The global reset global output enable pins are associated with Bank 2 and support all of the sysIO standards.

Hotsocketing

The I/O on the ispXPLD 5000MX devices are well suited for those applications that require hot socketing capability, when configured as LVCMOS or LVTTL. Hot socketing a device requires that the device, when powered down, can tolerate active signals on the I/Os and inputs without being damaged. Additionally, it requires that the effects of the powered-down device be minimal on active signals.

Programmable Drive Strength

The drive strength of I/Os that are programmed as LVCMOS is tightly controlled and can be programmed to a variety of different values. Thus the impedance an output driver can be closely match to the characteristic impedance of the line it is driving. This allows users to eliminate the need for external series termination resistors.

ispXPLD 5000MX Family Timing Adders

Parameter	Description	Base Param.	-4 Min.	-4 Max.	-45 Min.	-45 Max.	-5 Min.	-5 Max.	-52 Min.	-52 Max.	-75 Min.	-75 Max.	Units
t_{IOI} Input Adjusters													
LVTTL_in	Using 3.3V TTL	t_{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVCMOS_18_in	Using 1.8V CMOS	t_{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVCMOS_25_in	Using 2.5V CMOS	t_{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVCMOS_33_in	Using 3.3V CMOS	t_{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
AGP_1X_in	Using AGP 1x	t_{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
CTT25_in	Using CTT 2.5V	t_{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
CTT33_in	Using CTT 3.3V	t_{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
GTL+_in	Using GTL+	t_{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
HSTL_I_in	Using HSTL 2.5V, Class I	t_{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
HSTL_III_in	Using HSTL 2.5V, Class III	t_{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
HSTL_IV_in	Using HSTL 2.5V, Class IV	t_{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVDS_in	Using Low Voltage Differential Signaling (LVDS)	t_{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
LVPECL_in	Using Low Voltage PECL	t_{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
PCI_in	Using PCI	t_{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
SSTL2_I_in	Using SSTL 2.5V, Class I	t_{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
SSTL2_II_in	Using SSTL 2.5V, Class II	t_{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_in	Using SSTL 3.3V, Class I	t_{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
SSTL3_II_in	Using SSTL 3.3V, Class II	t_{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
t_{IOO} Output Adjusters – Output Signal Modifiers													
Slow Slew	Using Slow Slew (LVTTL and LVCMOS Outputs Only)	t_{IOBUF}, t_{IOEN}	—	0.9	—	0.9	—	0.9	—	0.9	—	0.9	ns
t_{IOO} Output Adjusters – Output Configurations													
LVTTL_out	Using 3.3V TTL Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.2	—	1.2	—	1.2	—	1.2	—	1.2	ns
LVCMOS_18_4mA_out	Using 1.8V CMOS Standard, 4mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
LVCMOS_18_5.33mA_out	Using 1.8V CMOS Standard, 5.33mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns

sysCLOCK PLL Timing

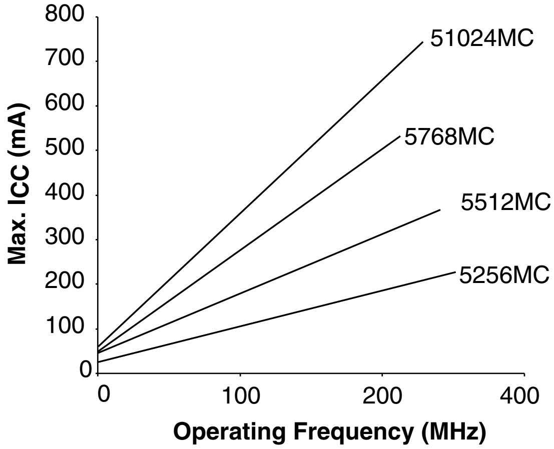
Over Recommended Operating Conditions

Symbol	Parameter	Conditions	Min	Max	Units
t_{PWH}	Input clock, high time	80% to 80%	1.2	—	ns
t_{PWL}	Input clock, low time	20% to 20%	1.2	—	ns
t_R, t_F	Input Clock, rise and fall time	20% to 80%	—	3.0	ns
t_{INSTB}	Input clock stability, cycle to cycle (peak)		—	+/- 250	ps
f_{MDIVIN}	M Divider input, frequency range		10	320	MHz
$f_{MDIVOUT}$	M Divider output, frequency range		10	320	MHz
f_{NDIVIN}	N Divider input, frequency range		10	320	MHz
$f_{NDIVOUT}$	N Divider output, frequency range		10	320	MHz
f_{VDIVIN}	V Divider input, frequency range		100	400	MHz
$f_{VDIVOUT}$	V Divider output, frequency range		10	320	MHz
$t_{OUTDUTY}$	Output clock, duty cycle		40	60	%
$t_{JIT(CC)}$	Output clock, cycle to cycle jitter (peak)	Clean reference. 10 MHz < $f_{MDIVOUT}$ < 20 MHz or 100MHz < f_{VDIVIN} < 160 MHz[1]	—	+/- 250	ps
		Clean reference. 20 MHz < $f_{MDIVOUT}$ < 320 MHz and 160MHz < f_{VDIVIN} < 320 MHz[1]	—	+/- 150	ps
$T_{JIT(PERIOD)}$[2]	Output clock, period jitter (peak)	Clean reference. 10 MHz < $f_{MDIVOUT}$ < 20 MHz or 100MHz < f_{VDIVIN} < 160 MHz[1]	—	+/- 300	ps
		Clean reference. 20 MHz < $f_{MDIVOUT}$ < 320 MHz and 160MHz < f_{VDIVIN} < 320 MHz[1]	—	+/- 150	ps
$t_{CLK\_OUT\_DLY}$	Input clock to CLK_OUT delay	Internal feedback	—	3.0	ns
t_{PHASE}	Input clock to external feedback delta	External feedback	—	600	ps
t_{LOCK}	Time to acquire phase lock after input stable		—	25	us
t_{PLL_DELAY}	Delay increment (Lead/Lag)	Typical = +/- 250ps	+/- 120	+/- 550	ps
t_{RANGE}	Total output delay range (lead/lag)		+/- 0.84	+/- 3.85	ns
t_{PLL_RSTW}	Minimum reset pulse width		—	1.8	ns
t_{CLK_IN}[3]	Global clock input delay		—	1.0	ns
$t_{PLL\_SEC\_DELAY}$	Secondary PLL output delay (t_{PLL_DELAY})		—	1.5	ns

1. This condition assures that the output phase jitter will remain within specification.
2. Accumulated jitter measured over 10,000 waveform samples.
3. Internal timing for reference only.

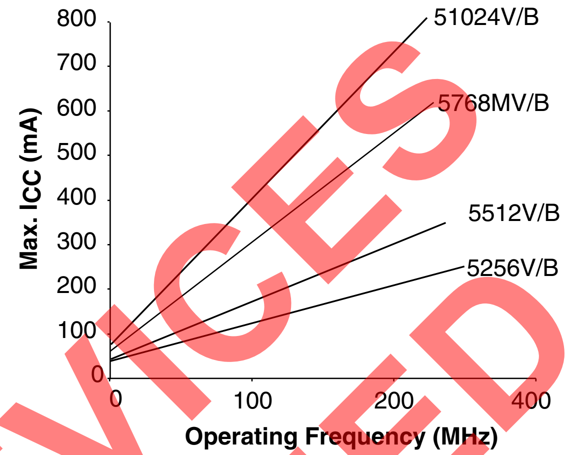
Power Consumption

ispXPLD 5000MC Typical I_{CC} vs. Frequency



Note: The device is configured with maximum number of 16-bit counters, no PLL, typical current at 1.8V, 25°C.

ispXPLD 5000MV/B Typical I_{CC} vs. Frequency



Note: The device is configured with maximum number of 16-bit counters, no PLL, typical current at 3.3V (MV) or 2.5V (MB), 25°C.

Power Estimation Coefficients

Device	K0	K1	K2	K3	K4	K5	K6	K7	DC	
									ispXPLD 5000MC	ispXPLD 5000MV/B
ispXPLD 5256	2.2	8.4	7	12	100	0.1379	0.0433	6.476	16	24
ispXPLD 5512	2.2	8.4	9.4	18	151	0.1379	0.0433	6.476	17	25
ispXPLD 5768	2.2	8.4	10.2	21	170	0.1379	0.0433	6.476	27	36
ispXPLD 51024	2.2	8.4	13	27.6	200	0.1379	0.0433	6.476	35	43

Note: For further information about the use of these coefficients, refer to TN1031 – Power Estimation in ispXPLD 5000MX Devices.

Memory Coefficients

Device	K8	K9	K10	K11
ispXPLD 5256	0.004719	0.0924	4.4	2.9
ispXPLD 5512	0.004719	0.0924	4.4	2.9
ispXPLD 5768	0.004719	0.0924	4.4	2.9
ispXPLD 51024	0.004719	0.0924	4.4	2.9

- K0 = Current per MFB input (µA/MHz)
- K1 = Current per Product Term (µA/MHz)
- K2 = Current per GRP from MFB (µA/MHz)
- K3 = Current per GRP from I/O (µA/MHz)
- K4 = Global clock tree current (µA/MHz)
- K5 = PLL digital (mA/MHz)
- K6 = PLL analog (mA/MHz)
- K7 = PLL analog baseline (mA)
- DC = Baseline current at 0Mhz (mA)
- K8 = CAM frequency component (mA/MHz)
- K9 = CAM DC component (mA)
- K10 = Current per row decoder (µA/MHz)
- K11 = Current per column driver (µA/MHz)

Switching Test Conditions

Figure 21 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 14.

Figure 21. Output Test Load, LVTTL and LVCMOS Standards

Table 14. Test Fixture Required Components

Test Condition	R_1	R_2	C_L	Timing Ref.	V_{CCO}
Default LVCMOS 1.8 I/O (L -> H, H -> L)	106	106	35pF	$V_{CCO}/2$	1.8V
LVCMOS I/O (L -> H, H -> L)	—	—	35pF	LVCMOS3.3 = 1.5V	LVCMOS3.3 = 3.0V
				LVCMOS2.5 = $V_{CCO}/2$	LVCMOS2.5 = 2.3V
				LVCMOS1.8 = $V_{CCO}/2$	LVCMOS1.8 = 1.65V
Default LVCMOS 1.8 I/O (Z -> H)	—	106	35pF	$V_{CCO}/2$	1.65V
Default LVCMOS 1.8 I/O (Z -> L)	106	—	35pF	$V_{CCO}/2$	1.65V
Default LVCMOS 1.8 I/O (H -> Z)	—	106	5pF	V_{OH} - 0.15	1.65V
Default LVCMOS 1.8 I/O (L -> Z)	106	—	5pF	V_{OL} + 0.15	1.65V

Note: Output test conditions for all other interfaces are determined by the respective standards.

ispXPLD 5256MX Logic Signal Connections

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
0	61N	H30	G17	H17	H31	B1
0	61P	H28	G16	H16	H29	C1
0	62N	H26	G15	H15	H27	D3
0	62P	H24	G14	H14	H25	C2
0	63N	H22	G13	H13	H23	E3
0	63P	H21	G12	H12	-	D2
-	-	VCC	-	-	-	VCC
0	64N	H20	G11	H11	-	E2
0	64P	H18/CLK_OUT0	G10	H10	H19	F2
0	65N	H16	G9	H9	H17	F1
0	65P	H14	G8	H8	H15	G1
-	-	GND	-	-	-	GND
0	66N	H12	G7	H7	H13	F3
-	-	VCCO0	-	-	-	VCCO0
0	66P	H10	G6	H6	H11	G5
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)
0	67N	H8	G5	H5	H9	H5
0	67P	H6/PLL_RST0	G4	H4	H7	G4
0	68N	H5	-	-	-	G3
0	68P	H4/PLL_FBK0	-	-	-	H3
0	69N	H2	-	-	H3	G2
0	69P	H0	-	-	H1	H1
-	GCLK0P	GCLK0	-	-	-	H2
-	-	VCCJ	-	-	-	See Power Supply and NC Connections Table
-	GCLK0N	GCLK1	-	-	-	J2
-	-	GND	-	-	-	GND
-	-	TDI	-	-	-	H6
-	-	TMS	-	-	-	H4
-	-	TCK	-	-	-	J6
-	-	TDO	-	-	-	K2
1	0P	A0/DATA0	A0	B0	A1	K3
1	0N	A2/DATA1	A1	B1	A3	J3
1	1P	A4/DATA2	A2	B2	-	J5
1	1N	A5/DATA3	A3	B3	-	J4
1	2P	A6/DATA4	A4	B4	A7	L2
1	2N	A8/DATA5	A5	B5	A9	M1
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)
1	3P	A10/DATA6	A6	B6	A11	K4
-	-	VCCO1	-	-	-	VCCO1
1	3N	A12/DATA7	A7	B7	A13	L3
-	-	GND	-	-	-	GND
1	4P	A14/INITB	A8	B8	A15	K5

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
2	20P	C14	-	-	C15	P11
2	20N	C16/VREF2	-	-	C17	T14
2	21P	C18	C8	D8	C19	R12
2	21N	C20	C9	D9	-	R13
2	22P	C21	C10	D10	-	N11
2	22N	C22	C11	D11	C23	T15
2	23P	C24	C12	D12	C25	R14
2	23N	C26	C13	D13	C27	N12
2	24P	C28	C14	D14	C29	P12
2	24N	C30	C15	D15	C31	R15
-	-	VCCO2	-	-	-	VCCO2
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)
2	25P	D0	-	-	D1	N15
2	25N	D2	-	-	D3	N14
2	26P	D4	C16	D16	-	N16
2	26N	D5	C17	D17	-	M16
2	27P	D6	C18	D18	D7	M14
2	27N	D8	C19	D19	D9	M15
-	-	VCC	-	-	-	VCC
2	28P	D10	C20	D20	D11	L13
2	28N	D12	C21	D21	D13	L12
2	29P	D14	C22	D22	D15	L15
2	29N	D16	C23	D23	D17	L16
-	-	GND	-	-	-	GND
2	30P	D18	C24	D24	D19	L14
-	-	VCCO2	-	-	-	VCCO2
2	30N	D20	C25	D25	-	K15
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)
2	31P	D21	C26	D26	-	K14
2	31N	D22	C27	D27	D23	K12
2	32P	D24	C28	D28	D25	K13
2	32N	D26	C29	D29	D27	J13
2	33P	D28	C30	D30	D29	J14
2	33N	D30	C31	D31	D31	J12
-	-	TOE	-	-	-	J15
-	-	RESET	-	-	-	J11
-	-	GOE0	-	-	-	H11
-	-	GOE1	-	-	-	H13
-	-	GNDP	-	-	-	See Power Supply and NC Connections Table
-	GCLK3N	GCLK2	-	-	-	H15
-	-	VCCP	-	-	-	See Power Supply and NC Connections Table
-	GCLK3P	GCLK3	-	-	-	H16

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
3	34N	E30	-	-	E31	H14
3	34P	E28	-	-	E29	G16
3	35N	E26	-	-	E27	G15
3	35P	E24/PLL_FBK1	-	-	E25	F15
3	36N	E22/PLL_RST1	E27	F27	E23	H12
3	36P	E21	E26	F26	-	G14
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
3	37N	E20	E25	F25	-	F16
-	-	VCCO3	-	-	-	VCCO3
3	37P	E18	E24	F24	E19	E16
-	-	GND	-	-	-	GND
3	38N	E16	E23	F23	E17	G13
3	38P	E14	E22	F22	E15	G12
3	39N	E12	E21	F21	E13	F14
3	39P	E10/CLK_OUT1	E20	F20	E11	E15
-	-	VCC	-	-	-	VCC
3	40N	E8	E19	F19	E9	D12
3	40P	E6	E18	F18	E7	B14
3	41N	E5	E17	F17	-	C13
3	41P	E4	E16	F16	-	A14
3	42N	E2	E31	F31	E3	A13
3	42P	E0	E30	F30	E1	B13
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
-	-	VCCO3	-	-	-	VCCO3
3	43N	F30	E15	F15	F31	B11
3	43P	F28	E14	F14	F29	C11
3	44N	F26	E13	F13	F27	B10
3	44P	F24	E12	F12	F25	A10
3	45N	F22	E11	F11	F23	C10
3	45P	F21	E10	F10	-	D10
3	46N	F20	E9	F9	-	C9
3	46P	F18	E8	F8	F19	E9
3	47N	F16/VREF3	E29	F29	F17	D9
3	47P	F14	E28	F28	F15	F9
3	48N	F12	E7	F7	F13	A9
3	48P	F10	E6	F6	F11	F8
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
3	49N	F8	E5	F5	F9	E8
-	-	VCCO3	-	-	-	VCCO3
3	49P	F6	E4	F4	F7	A8
3	50N	F5	E3	F3	-	B9
3	50P	F4	E2	F2	-	D8
-	-	VCC	-	-	-	VCC

ispXPLD 5512MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
2	47N	G26	—	—	G27	108	N14	V19
—	—	GND (Bank 2)	—	—	—	109	GND (Bank 2)	GND (Bank 2)
2	48P	G28	F16	H16	G29	110	N16	T18
2	48N	G30	F17	H17	G31	111	M16	R17
2	49P	H0	F18	H18	H1	112	M14	U19
2	49N	H2	F19	H19	H3	113	M15	T19
2	50P	H4	E24	—	H5	—	—	V20
—	—	V_{CC}	—	—	—	114	VCC	VCC
2	50N	H6	E26	—	H7	—	NC	U20
2	51P	H8	F20	H20	H9	115	L13	W20
2	51N	H10	F21	H21	H11	116	L12	Y21
2	52P	H12	F22	H22	H13	117	L15	R18
2	52N	H14	F23	H23	H15	118	L16	R19
—	—	GND	—	—	—	119	GND	GND
2	53P	H16	F24	H24	H17	120	L14	W21
—	—	V_{CCO2}	—	—	—	121	V_{CCO2}	V_{CCO2}
2	53N	H18	F25	H25	H19	122	K15	Y22
—	—	GND (Bank 2)	—	—	—	123	GND (Bank 2)	GND (Bank 2)
2	54P	H20	F26	H26	H21	124	K14	R20
2	54N	H22	F27	H27	H23	125	K12	P20
2	55P	H24	F28	H28	H25	126	K13	T21
2	55N	H26	F29	H29	H27	127	J13	R21
2	56P	H28	F30	H30	H29	128	J14	U21
2	56N	H30	F31	H31	H31	129	J12	V21
—	—	TOE	—	—	—	130	J15	W22
—	—	RESET	—	—	—	131	J11	V22
—	—	GOE0	—	—	—	132	H11	T22
—	—	GOE1	—	—	—	133	H13	R22
—	—	GNDP	—	—	—	See Power Supply and NC Connections Table		
—	GCLK3N	GCLK2	—	—	—	135	H15	P16
—	—	V_{CCP}	—	—	—	See Power Supply and NC Connections Table		
—	GCLK3P	GCLK3	—	—	—	137	H16	N16
3	57N	I30	—	—	I31	138	H14	J22
3	57P	I28	—	—	I29	139	G16	H22
3	58N	I26	—	—	I27	140	G15	E22
3	58P	I24/PLL_FBK1	—	—	I25	141	F15	E21
3	59N	I22/PLL_RST1	I27	K27	I23	142	H12	G22
3	59P	I20	I26	K26	I21	143	G14	F21
—	—	GND (Bank 3)	—	—	—	144	GND (Bank 3)	GND (Bank 3)
3	60N	I18	I25	K25	I19	145	F16	H21
—	—	VCCO3	—	—	—	146	V_{CCO3}	V_{CCO3}
3	60P	I16	I24	K24	I17	147	E16	G21
—	—	GND	—	—	—	148	GND	GND

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	GCLK3N	GCLK2	-	-	-	H15	P16
-	-	VCCP	-	-	-	See Power Supply and NC Connections Table	
-	GCLK3P	GCLK3	-	-	-	H16	N16
3	61N	J0	L31	J31	-	H14	J22
3	61P	J2	L30	J30	J3	G16	H22
3	62N	J4	L29	J29	J5	—	N19
3	62P	J6	L28	J28	J7	—	P15
3	63N	J8	L27	J27	J9	—	P21
3	63P	J10	L26	J26	J11	—	N15
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	64N	J12	L25	J25	J13	—	M15
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	64P	J14	L24	J24	J15	—	N20
-	-	GND	-	-	-	GND	GND
3	65N	J16	L23	J23	J17	—	P22
3	65P	J18	L22	J22	J19	—	N21
3	66N	J20	L21	J21	J21	—	N17
3	66P	J22	L20	J20	J23	—	M20
3	67N	J24	L19	J19	J25	—	P17
-	-	VCC	-	-	-	VCC	VCC
3	67P	J26	L18	J18	J27	—	P18
3	68N	J28	L17	J17	J29	—	M21
3	68P	J30	L16	J16	J31	—	M17
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	69N	L0	L15	J15	-	—	L20
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	69P	L2	L14	J14	L3	—	N18
3	70N	L4	L13	J13	L5	—	L21
3	70P	L6	L12	J12	L7	—	M18
3	71N	L8	L11	J11	L9	—	L22
3	71P	L10	L10	J10	L11	—	L17
3	72N	L12	L9	J9	L13	—	K22
3	72P	L14	L8	J8	L15	—	L18
3	73N	L16	L7	J7	L17	—	K21
3	73P	L18	L6	J6	L19	—	K18
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	74N	L20	L5	J5	L21	—	K20
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	74P	L22	L4	J4	L23	—	K17
3	75N	L24	L3	J3	L25	—	K19
3	75P	L26	L2	J2	L27	—	J17
3	76N	L28	L1	J1	L29	G15	E22

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
3	93N	O0	P31	N31	O1	A13	E17
3	93P	O2	P30	N30	O3	B13	D17
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	94N	O4	N11	M21	O5	D11	B18
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	94P	O6	N10	M20	O7	B12	A18
-	-	GND	-	-	-	GND	GND
3	95N	O8	N9	M18	O9	C12	C17
-	-	VCC	-	-	-	VCC	VCC
3	95P	O10	N8	M16	O11	E11	B17
3	96N	O12	N7	M12	O13	—	C16
3	96P	O14	N6	M10	O15	—	B16
3	97N	O16	N5	M8	O17	—	F13
3	97P	O18	N4	M6	O19	—	F15
3	98N	O20	N3	M5	O21	—	D16
3	98P	O22	N2	M4	O23	E10	E16
3	99N	O24	N1	M2	O25	A12	A16
3	99P	O26	N0	M0	O27	A11	A15
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	100N	O28	P15	N15	O29	B11	B15
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	100P	O30	P14	N14	O31	C11	A14
3	101N	P0	P13	N13	P1	B10	D15
3	101P	P2	P12	N12	P3	A10	E15
3	102N	P4	P11	N11	P5	C10	D14
3	102P	P6	P10	N10	P7	D10	F14
3	103N	P8	P9	N9	P9	C9	A13
3	103P	P10	P8	N8	P11	E9	B13
3	104N	P12/VREF3	P29	N29	P13	D9	C14
3	104P	P14	P28	N28	P15	F9	E14
3	105N	P16	P7	N7	P17	A9	E13
3	105P	P18	P6	N6	P19	F8	F12
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	106N	P20	P5	N5	P21	E8	D13
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	106P	P22	P4	N4	P23	A8	C13
3	107N	P24	P3	N3	P25	B9	E12
-	-	GND	-	-	-	GND	GND
3	107P	P26	P2	N2	P27	D8	C12
-	-	VCC	-	-	-	VCC	VCC
3	108N	P28	P1	N1	P29	B8	B12
3	108P	P30	P0	N0	P31	C8	A12
0	109N	Q30	Q31	S31	Q31	B7	E11

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	VCC	-	-	-	VCC	VCC
0	109P	Q28	Q30	S30	Q29	A7	C11
-	-	GND	-	-	-	GND	GND
0	110N	Q26	Q29	S29	Q27	D7	B11
0	110P	Q24	Q28	S28	Q25	C7	A11
0	111N	Q22	Q27	S27	Q23	B6	F11
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	111P	Q20	Q26	S26	Q21	E7	F10
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	112N	Q18	Q25	S25	Q19	E6	E10
0	112P	Q16	Q24	S24	Q17	A6	C10
0	113N	Q14/VREF0	Q3	S3	Q15	A5	D10
0	113P	Q12	Q2	S2	Q13	A4	B10
0	114N	Q10	Q23	S23	Q11	B5	A10
0	114P	Q8	Q22	S22	Q9	A3	A9
0	115N	Q6	Q21	S21	Q7	B4	C9
0	115P	Q4	Q20	S20	Q5	B3	D9
0	116N	Q2	Q19	S19	Q3	C5	F9
0	116P	Q0	Q18	S18	Q1	C6	E9
0	117N	R30	Q1	S1	R31	D5	A8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	117P	R28	Q0	S0	R29	D6	B8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	118N	R26	S29	-	R27	—	A7
0	118P	R24	S28	-	R25	—	B7
0	119N	R22	S27	-	R23	—	A5
0	119P	R20	S26	-	R21	—	B5
0	120N	R18	S25	-	R19	—	B6
0	120P	R16	S24	-	R17	—	C7
0	121N	R14	S23	-	R15	—	E8
0	121P	R12	S22	-	R13	—	E7
0	122N	R10	S21	-	R11	—	E6
-	-	VCC	-	-	-	VCC	VCC
0	122P	R8	S20	-	R9	—	D6
-	-	GND	-	-	-	GND	GND
0	123N	R6	S19	-	R7	—	D8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	123P	R4	S18	-	R5	—	F8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	124N	R2	S17	-	R3	—	F7
0	124P	R0	S16	-	R1	—	D7
0	125N	S30	S15	-	S31	A2	C6
0	125P	S28	S14	-	S29	B2	C5

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	31P	G26	H16	-	G27	V6	AB7
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	31N	G24	H18	-	G25	V7	AC7
-	-	GND	-	-	-	GND	GND
1	32P	G22	H20	-	G23	Y5	AB6
-	-	VCC	-	-	-	VCC	VCC
1	32N	G20	H22	-	G21	AA5	AC6
1	33P	G18	-	-	G19	Y6	AC8
1	33N	G16	-	-	G17	Y7	AC9
1	34P	G14	-	-	G15	AA6	AC5
1	34N	G12	-	-	G13	AA7	AD4
1	35P	G10	-	-	G11	W7	AD5
1	35N	G8	-	-	G9	V8	AD6
1	36P	G6	-	-	G7	W8	AD7
1	36N	G4	-	-	G5	U9	AD8
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
-	-	CFG0	-	-	-	U10	AE3
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	37P	G0	G16	E16	G1	AB7	AD9
1	37N	H30	G17	E17	H31	AA8	AD10
1	38P	H28	G18	E18	H29	AB8	AE4
1	38N	H26	G19	E19	H27	AB9	AE5
1	39P	H24	G20	E20	H25	W9	AE6
1	39N	H22	G21	E21	H23	Y9	AE7
1	40P	H20	G22	E22	H21	AB10	AE8
1	40N	H18	G23	E23	H19	AA10	AE9
1	-	H16/VREF1	-	-	H17	W10	AE10
1	41P	H14	G24	E24	H15	Y10	AF3
1	41N	H12	G25	E25	H13	Y11	AF4
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	42P	H10	G26	E26	H11	V9	AF5
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	42N	H8	G27	E27	H9	V10	AF6
1	43P	H6	G28	E28	H7	AA11	AF7
-	-	GND	-	-	-	GND	GND
1	43N	H4	G29	E29	H5	AB11	AF8
-	-	VCC	-	-	-	VCC	VCC
1	44P	H2	G30	E30	H3	U11	AF9
1	44N	H0	G31	E31	H1	V11	AF10
2	45P	I0	J0	L0	I1	AB12	AF17
-	-	VCC	-	-	-	VCC	VCC
2	45N	I2	J1	L1	I3	AA12	AF18

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	110N	U4	X25	V25	U5	H21	J21
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	110P	U6	X24	V24	U7	G21	H21
-	-	GND	-	-	-	GND	GND
3	111N	U8	X23	V23	U9	D22	G25
3	111P	U10	X22	V22	U11	D21	G24
3	112N	U12	X21	V21	U13	J20	G23
3	112P	U14/CLK_OUT1	X20	V20	U15	J19	G22
3	113N	U16	V31	-	U17	E20	J20
-	-	VCC	-	-	-	VCC	VCC
3	113P	U18	V30	U30	U19	F20	H20
3	114N	U20	V29	U28	U21	H17	G26
3	114P	U22	V28	U26	U23	H18	F25
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	115N	U24	V27	-	U25	J18	F24
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	115P	U26	V26	-	U27	H19	F23
3	116N	U28	V25	-	U29	G20	G21
3	116P	U30	V24	-	U31	G19	F22
-	-	GND	-	-	-	GND	GND
3	117N	V0	V23	-	V1	C22	F26
-	-	VCC	-	-	-	VCC	VCC
3	117P	V2	V22	-	V3	C21	E26
3	118N	V4	V21	-	V5	D20	E25
3	118P	V6	V20	-	V7	C19	E24
3	119N	V8	V19	-	V9	F19	E23
3	119P	V10	V18	-	V11	E19	E22
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	120N	V12	V17	-	V13	G18	D26
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	120P	V14	V16	-	V15	F18	D25
3	121N	V16	V15	-	V17	B20	D24
3	121P	V18	V14	-	V19	B19	D23
3	122N	V20	V13	-	V21	A20	C26
3	122P	V22	V12	-	V23	A19	C25
3	123N	V24	X19	V19	V25	D18	G19
3	123P	V26	X18	V18	V27	C18	F19
3	124N	V28	X17	V17	V29	G17	G18
3	124P	V30	X16	V16	V31	F16	F18
3	125N	W0	X31	V31	W1	E17	F20
3	125P	W2	X30	V30	W3	D17	E20
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)

ispXPLD 5000MC (1.8V) Commercial Devices (Continued)

Device	Part Number	Macrocells	Voltage (V)	t_{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5768MC	LC5768MC-5F256C	768	1.8	5.0	fpBGA	256	193	C
	LC5768MC-75F256C	768	1.8	7.5	fpBGA	256	193	C
	LC5768MC-5F484C	768	1.8	5.0	fpBGA	484	317	C
	LC5768MC-75F484C	768	1.8	7.5	fpBGA	484	317	C
LC51024MC	LC51024MC-52F484C	1024	1.8	5.2	fpBGA	484	317	C
	LC51024MC-75F484C	1024	1.8	7.5	fpBGA	484	317	C
	LC51024MC-52F672C	1024	1.8	5.2	fpBGA	672	381	C
	LC51024MC-75F672C	1024	1.8	7.5	fpBGA	672	381	C

ispXPLD 5000MC (1.8V) Industrial Devices

Device	Part Number	Macrocells	Voltage (V)	t_{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MC	LC5256MC-5F256I	256	1.8	5.0	fpBGA	256	141	I
	LC5256MC-75F256I	256	1.8	7.5	fpBGA	256	141	I
LC5512MC	LC5512MC-75Q208I	512	1.8	7.5	PQFP	208	149	I
	LC5512MC-75F256I	512	1.8	7.5	fpBGA	256	193	I
	LC5512MC-75F484I	512	1.8	7.5	fpBGA	484	253	I
LC5768MC	LC5768MC-75F256I	768	1.8	7.5	fpBGA	256	193	I
	LC5768MC-75F484I	768	1.8	7.5	fpBGA	484	317	I
LC51024MC	LC51024MC-75F484I	1024	1.8	7.5	fpBGA	484	317	I
	LC51024MC-75F672I	1024	1.8	7.5	fpBGA	672	381	I

ispXPLD 5000MB (2.5V) Commercial Devices

Device	Part Number	Macrocells	Voltage (V)	t_{PD} (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MB	LC5256MB-4F256C	256	2.5	4.0	fpBGA	256	141	C
	LC5256MB-5F256C	256	2.5	5.0	fpBGA	256	141	C
	LC5256MB-75F256C	256	2.5	7.5	fpBGA	256	141	C
LC5512MB	LC5512MB-45Q208C	512	2.5	4.5	PQFP	208	149	C
	LC5512MB-75Q208C	512	2.5	7.5	PQFP	208	149	C
	LC5512MB-45F256C	512	2.5	4.5	fpBGA	256	193	C
	LC5512MB-75F256C	512	2.5	7.5	fpBGA	256	193	C
	LC5512MB-45F484C	512	2.5	4.5	fpBGA	484	253	C
	LC5512MB-75F484C	512	2.5	7.5	fpBGA	484	253	C
LC5768MB	LC5768MB-5F256C	768	2.5	5.0	fpBGA	256	193	C
	LC5768MB-75F256C	768	2.5	7.5	fpBGA	256	193	C
	LC5768MB-5F484C	768	2.5	5.0	fpBGA	484	317	C
	LC5768MB-75F484C	768	2.5	7.5	fpBGA	484	317	C
LC51024MB	LC51024MB-52F484C	1024	2.5	5.2	fpBGA	484	317	C
	LC51024MB-75F484C	1024	2.5	7.5	fpBGA	484	317	C
	LC51024MB-52F672C	1024	2.5	5.2	fpBGA	672	381	C
	LC51024MB-75F672C	1024	2.5	7.5	fpBGA	672	381	C